### **MOSFET** – Power, Single, **N-Channel** 100 V, 15 mΩ, 50 A

#### Features

- Small Footprint (5x6 mm) for Compact Design
- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Q<sub>G</sub> and Capacitance to Minimize Driver Losses
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant



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V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
100 V	15 mΩ @ 10 V	50 A

MAXIMUM RATINGS	(T <sub>J</sub> = 25°0	C unless otherv	vise noted)		
Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V <sub>DSS</sub>	100	V
Gate-to-Source Voltage			V <sub>GS</sub>	±20	V
Continuous Drain	Steady State	T <sub>C</sub> = 25°C	I <sub>D</sub>	50	А
Current R <sub>θJC</sub> (Notes 1, 2, 3)		T <sub>C</sub> = 100°C	1	32	
Power Dissipation $R_{\theta JC}$ (Notes 1, 2)		$T_{C} = 25^{\circ}C$	PD	77	W
		$T_{\rm C} = 100^{\circ}{\rm C}$	1	32	
Continuous Drain Current $R_{\theta JA}$ (Notes 1, 2, 3)	Steady State	$T_A = 25^{\circ}C$	Ι <sub>D</sub>	10	А
		$T_A = 100^{\circ}C$		6.4	
Power Dissipation $R_{\theta JA}$ (Notes 1 & 2)		$T_A = 25^{\circ}C$	PD	3.1	W
		$T_A = 100^{\circ}C$		1.3	
Pulsed Drain Current	T <sub>A</sub> = 25	°C, t <sub>p</sub> = 10 μs	I <sub>DM</sub>	180	А
Operating Junction and Storage Temperature			T <sub>J</sub> , T <sub>stg</sub>	–55 to + 150	°C
Source Current (Body Diode)			۱ <sub>S</sub>	60	А
Single Pulse Drain-to-Source Avalanche Energy (I <sub>L(pk)</sub> = 24 A)			E <sub>AS</sub>	29	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be

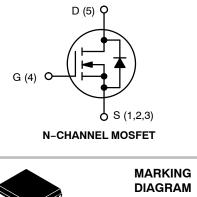
#### assumed, damage may occur and reliability may be affected. THERMAL RESISTANCE MAXIMUM RATINGS

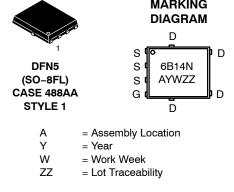
Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	1.6	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	40	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm<sup>2</sup>, 2 oz. Cu pad.

Maximum current for pulses as long as 1 second is higher but is dependent 3. on pulse duration and duty cycle.





#### **ORDERING INFORMATION**

See detailed ordering, marking and shipping information on page 5 of this data sheet.

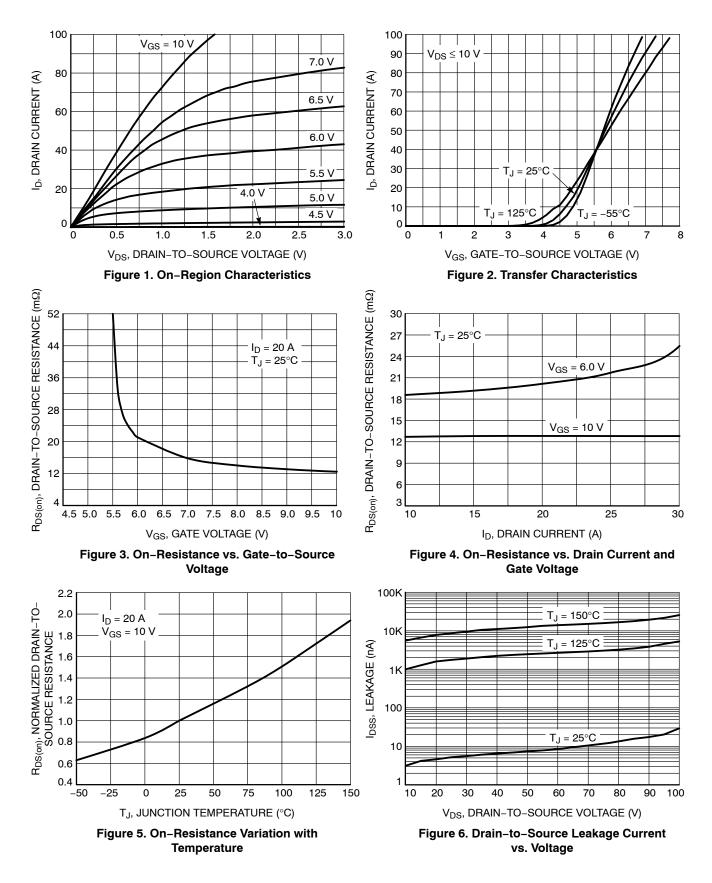
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#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise specified)

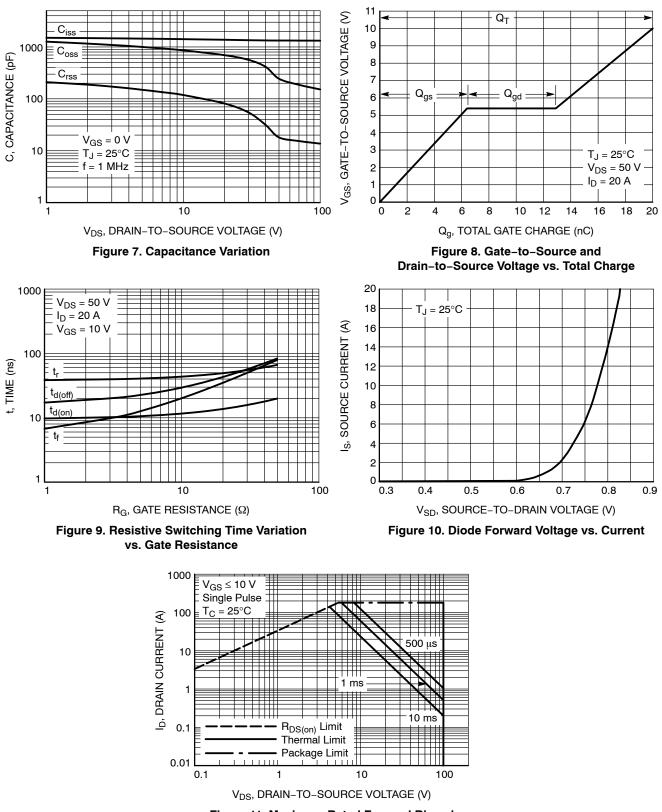
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ = 0 V, I <sub>D</sub> = 250 $\mu$ A		100			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> / T <sub>J</sub>				80		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V,	T <sub>J</sub> = 25 °C			10	μΑ
		V <sub>DS</sub> = 80 V	T <sub>J</sub> = 125°C			100	
Gate-to-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = 20 V				100	nA
ON CHARACTERISTICS (Note 4)						-	
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$		2.0		4.0	V
Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>				-8.5		mV/°C
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 20 A		12.2	15	mΩ
		V <sub>GS</sub> = 6 V	I <sub>D</sub> = 10 A		18.5	23	mΩ
CHARGES, CAPACITANCES & GATE RE	SISTANCE		•				
Input Capacitance	C <sub>ISS</sub>			1300		pF	
Output Capacitance	C <sub>OSS</sub>	V <sub>GS</sub> = 0 V, f = 1 MHz, V <sub>DS</sub> = 50 V			260		
Reverse Transfer Capacitance	C <sub>RSS</sub>				18		
Total Gate Charge	Q <sub>G(TOT)</sub>	$V_{GS}$ = 10 V, $V_{DS}$ = 50 V; $I_{D}$ = 20 A $T_{J}$ = 25 °C			20		nC
Threshold Gate Charge	Q <sub>G(TH)</sub>				2.2		
Gate-to-Source Charge	Q <sub>GS</sub>				6.4		
Gate-to-Drain Charge	Q <sub>GD</sub>				6.5		
Plateau Voltage	V <sub>GP</sub>				5.4		V
Gate Resistance	R <sub>G</sub>				1.0		Ω
SWITCHING CHARACTERISTICS (Note \$	5)						
Turn-On Delay Time	t <sub>d(ON)</sub>				9.6		
Rise Time	t <sub>r</sub>	$V_{CC} = 10 V V_{CC}$	os = 50 V		39		1
Turn-Off Delay Time	t <sub>d(OFF)</sub>	$V_{GS}$ = 10 V, $V_{DS}$ = 50 V, I <sub>D</sub> = 20 A, R <sub>G</sub> = 1.0 $\Omega$			17		ns
Fall Time	t <sub>f</sub>				6.8		
DRAIN-SOURCE DIODE CHARACTERIS	STICS						
Forward Diode Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0 V,	$T_J = 25^{\circ}C$		0.83	1.2	2 V
		$I_{\rm S} = 20 \rm{A}$	T <sub>J</sub> = 125°C		0.8		
Reverse Recovery Time	t <sub>RR</sub>	V <sub>GS</sub> = 0 V, dI <sub>S</sub> /dt = 100 A/μs, I <sub>S</sub> = 20 A			45		
Charge Time	ta				23		ns
Discharge Time	t <sub>b</sub>				22		
Reverse Recovery Charge	Q <sub>RR</sub>				50		nC

unless otherwise noted. Product Pro ance is indicated in th ectrical cteristics for the listed test co litions performance may not be indicated by the Electrical Characteristics for the listed test conditions. 4. Pulse Test: pulse width  $\leq 300 \ \mu$ s, duty cycle  $\leq 2\%$ . 5. Switching characteristics are independent of operating junction temperatures.

#### **TYPICAL CHARACTERISTICS**



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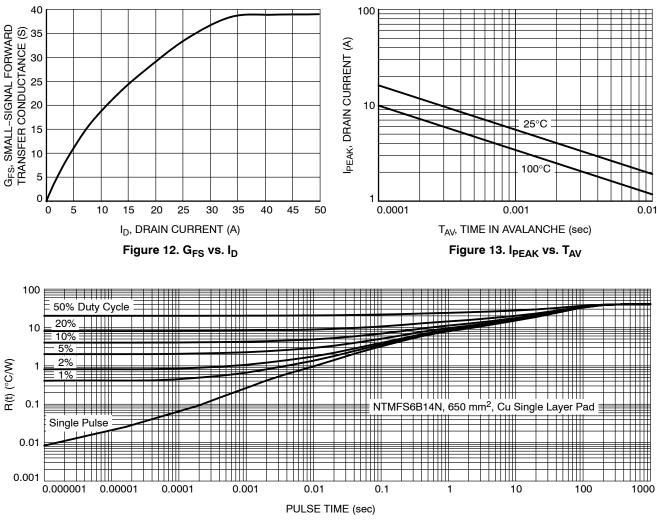


Figure 14. Thermal Response

#### **DEVICE ORDERING INFORMATION**

Device	Marking	Package	Shipping <sup>†</sup>
NTMFS6B14NT1G	6B14N	DFN5 (Pb–Free)	1500 / Tape & Reel
NTMFS6B14NT3G	6B14N	DFN5 (Pb–Free)	5000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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